



Designation: D3380 – 22

Standard Test Method for Relative Permittivity (Dielectric Constant) and Dissipation Factor of Polymer-Based Microwave Circuit Substrates¹

This standard is issued under the fixed designation D3380; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

1. Scope*

1.1 This test method permits the rapid measurement of apparent relative permittivity and loss tangent (dissipation factor) of metal-clad polymer-based circuit substrates in the X-band (8 GHz to 12.4 GHz).

1.2 This test method is suitable for testing PTFE (polytetrafluorethylene) impregnated glass cloth or random-oriented fiber mats, glass fiber-reinforced polystyrene, polyphenyleneoxide, irradiated polyethylene, and similar materials having a nominal specimen thickness of $\frac{1}{16}$ in. (1.6 mm). The materials listed in the preceding sentence have been used in commercial applications at nominal frequency of 9.6 GHz.

NOTE 1—See **Appendix X1** for additional information about range of permittivity, thickness other than $\frac{1}{16}$ in. (1.6 mm), and tests at frequencies other than 9.6 GHz.

1.3 The values stated in inch-pound units are to be regarded as standard. The values given in parentheses are mathematical conversions to SI units that are provided for information only and are not considered standard.

1.4 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety, health, and environmental practices and determine the applicability of regulatory limitations prior to use.*

1.5 *This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.*

¹ This test method is under the jurisdiction of ASTM Committee D09 on Electrical and Electronic Insulating Materials and is the direct responsibility of Subcommittee D09.12 on Electrical Tests.

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2. Referenced Documents

2.1 ASTM Standards:²

D150 Test Methods for AC Loss Characteristics and Permittivity (Dielectric Constant) of Solid Electrical Insulation
D1711 Terminology Relating to Electrical Insulation
D2520 Test Methods for Complex Permittivity (Dielectric Constant) of Solid Electrical Insulating Materials at Microwave Frequencies and Temperatures to 1650 °C
D6054 Practice for Conditioning Electrical Insulating Materials for Testing (Withdrawn 2012)³

2.2 IPC Standards:⁴

IPC-TM-650 Test Methods Manual Method 2.5.5.5.
IPC-MF-4562 Metal Foil for Printed Wiring Applications.

2.3 IEEE Standards:⁵

Standard No. 488.1 Standard Digital Interface for Programmable Instrumentation.
Standard No. 488.2 Standards, Codes, Formats, Protocols and Common Commands for Use with ANSI and IEEE Standard 488.1.

3. Terminology

3.1 *Definitions*—See Terminology D1711 for the definitions of terms used in this test method. See also Test Methods D2520, D150, and IPC TM-650 for additional information regarding the terminology.

3.2 Definitions of Terms Specific to This Standard:

3.2.1 *D*—a symbol used in this test method for the dissipation factor (loss tangent).

² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

³ The last approved version of this historical standard is referenced on www.astm.org.

⁴ Available from IPC, 3000 Lakeside Drive, Suite 309S, Bannockburn, IL 60015.

⁵ Available from Institute of Electrical and Electronics Engineers, Inc. (IEEE), 445 Hoes Ln., P.O. Box 1331, Piscataway, NJ 08854-1331, <http://www.ieee.org>.

*A Summary of Changes section appears at the end of this standard

3.2.2 ΔL —a correction factor associated with length which corrects for the fringing capacitance at the ends of the resonator element.

3.2.3 κ' —symbol used in this test method to denote relative permittivity.

3.2.3.1 *Discussion*—The preferred symbol for permittivity is Greek kappa prime, but some persons use other symbols to denote this property such as DK , SIC , or ϵ'_R .

3.2.4 *microstrip line, n*—a microwave transmission line employing a flat strip conductor bonded to one surface of a dielectric board or sheet, the other surface of which is clad with, or bonded to, a continuous conductive foil or plate which is substantially wider than the strip.

3.2.4.1 *Discussion*—Microstrip provides easier accessibility than stripline for attaching components and devices to the strip circuitry.

3.2.5 *microwave substrate, n*—a board or sheet of low-loss dielectric material that is clad with metal foil either on one or both surfaces, from which all metal is removed by etching prior to testing.

3.2.6 *stripline, n*—microwave transmission line using a flat strip conductor clamped, or bonded, between two substantially wider dielectric boards.

3.2.6.1 *Discussion*—The outer surfaces of both boards are bonded to, or in intimate contact with, conducting foils or plates (ground planes). Picture a stripline as a flattened version of cylindrical coaxial cable.

3.2.7 *stripline resonator, n*—a disconnected section of stripline loosely coupled at each end by capacitive gaps to feed or probe lines.

3.2.7.1 *Discussion*—The strip becomes resonant at those frequencies at which the strip length, increased by an increment due to the fringing fields at the ends, is equal to an integral multiple of half-wavelengths in the dielectric. As frequency varies gradually, the power transmitted from the input to the output feed lines becomes maximum at resonance, and falls off sharply to essentially zero at frequencies which are a few parts per thousand above and below resonance.

4. Summary of Test Method

4.1 Substrate specimens, with metal cladding removed, become the supporting dielectric spacers of a microwave stripline resonator when properly positioned and clamped in the test fixture. The measured values of resonant frequency of the stripline resonator and the half-power frequencies are used to compute the relative permittivity (dielectric constant or κ') and the dissipation factor (D) of the test specimen. The test specimen consists of one or more pairs of test cards.

5. Significance and Use

5.1 Permittivity and dissipation factor are fundamental design parameters for design of microwave circuitry. Permittivity plays a principal role in determining the wavelength and the impedance of transmission lines. Dissipation factor (along with copper losses) influence attenuation and power losses.

5.2 This test method is suitable for polymeric materials having permittivity in the order of two to eleven. Such

materials are popular in applications of stripline and microstrip configurations used in the 1 GHz to 18 GHz range.

5.3 This test method is suitable for design, development, acceptance specifications, and manufacturing quality control.

NOTE 2—See Appendix X1 for additional information regarding significance of this test method and the application of the results.

6. Apparatus

6.1 The preferred assembly fixture shown in Figs. 1-3 is hereby designated Fixture A. This design of test specimen fixture provides advantages over the design of Fixture B, shown in Figs. 4-7.

6.1.1 The Fixture B design has been included since this fixture has been, and still is, in service in numerous laboratories.

6.1.2 The Fixture B design relies upon close control of the room temperature in the laboratory for control of the test specimen temperature.

6.1.3 Changing of test pattern cards in the Fixture B design is less convenient than with the Fixture A design.

6.1.4 For Fixture A, the preferred assembly for Resonator Card and Specimen uses a Lap Conductor Joint. See Fig. 3 for details.

6.2 *Fixture A*—The elements of the fixture include the following:

6.2.1 *Resonator Pattern Card* (see Fig. 8),

6.2.2 *Base Stripline Board* (see Fig. 9),

6.2.3 *Base Cover Board* (see Fig. 10),

6.2.4 *End-Launcher Bodies*, adapted (see Fig. 11),

6.2.5 *Aluminum Base Plates* (see Fig. 12),

6.2.6 *Aluminum Clamping Plates* (see Fig. 13),

6.2.7 *Aluminum Blocks*, for temperature control (see Fig. 14), and

6.2.8 *Sliders and Blocks* (see Fig. 15).

6.3 *Microwave Signal Source*, capable of providing an accurate signal. An accurate signal provides a leveled power output that falls within a 0.1 dB range during the required time period and over the range of frequency needed to make a permittivity and loss measurement, and maintains output

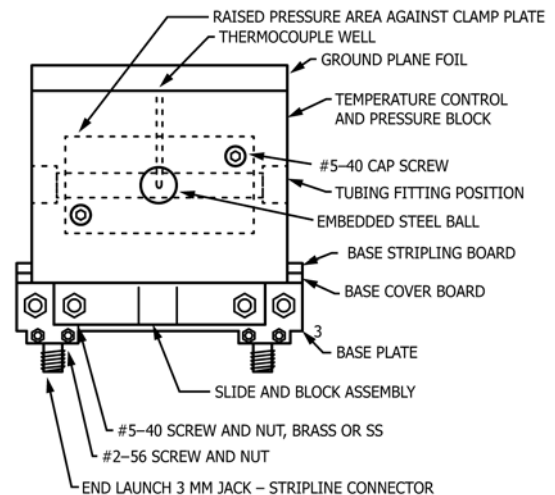


FIG. 1 Face View of Fixture Assembly